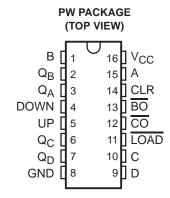
- **Qualified for Automotive Applications**
- Wide Operating Voltage Range of 2 V to 6 V
- **Outputs Can Drive Up To 10 LSTTL Loads**
- Low Power Consumption, 80-µA Max I_{CC}
- Typical $t_{pd} = 20 \text{ ns}$
- ±4-mA Output Drive at 5 V
- Low Input Current of 1 µA Max
- **Look-Ahead Circuitry Enhances Cascaded** Counters

description/ordering information

The SN74HC193 device is a 4-bit synchronous, reversible, up/down binary counter. Synchronous operation is provided by having all flip-flops clocked simultaneously so that the outputs change simultaneously with each other when dictated by the steering logic. This mode of operation eliminates the output counting spikes normally associated with asynchronous (ripple-clock) counters.

- **Fully Synchronous in Count Modes**
- Parallel Asynchronous Load for Modulo-N **Count Lengths**
- **Asynchronous Clear**



The outputs of the four flip-flops are triggered on a low-to-high-level transition of either count (clock) input (UP or DOWN). The direction of counting is determined by which count input is pulsed while the other count input is high.

All four counters are fully programmable; that is, each output may be preset to either level by placing a low on the load (LOAD) input and entering the desired data at the data inputs. The output changes to agree with the data inputs independently of the count pulses. This feature allows the counters to be used as modulo-N dividers simply by modifying the count length with the preset inputs.

A clear (CLR) input has been provided that forces all outputs to the low level when a high level is applied. The clear function is independent of the count and \overline{LOAD} inputs.

This counter was designed to be cascaded without the need for external circuitry. The borrow (BO) output produces a low-level pulse while the count is zero (all outputs low) and DOWN is low. Similarly, the carry (\overline{CO}) output produces a low-level pulse while the count is maximum (9 or 15), and UP is low. The counter then can be cascaded easily by feeding \overline{BO} and \overline{CO} to DOWN and UP, respectively, of the succeeding counter.

ORDERING INFORMATION[†]

TA	PACKAC	GE‡	ORDERABLE PART NUMBER	TOP-SIDE MARKING
-40°C to 125°C	TSSOP – PW	Reel of 2000	SN74HC193QPWRQ1	HC193Q
–40°C to 85°C	TSSOP - PW	Reel of 2000	SN74HC193IPWRQ1	HC193I

[†] For the most current package and ordering information, see the Package Option Addendum at the end of this document, or see the TI web site at http://www.ti.com.

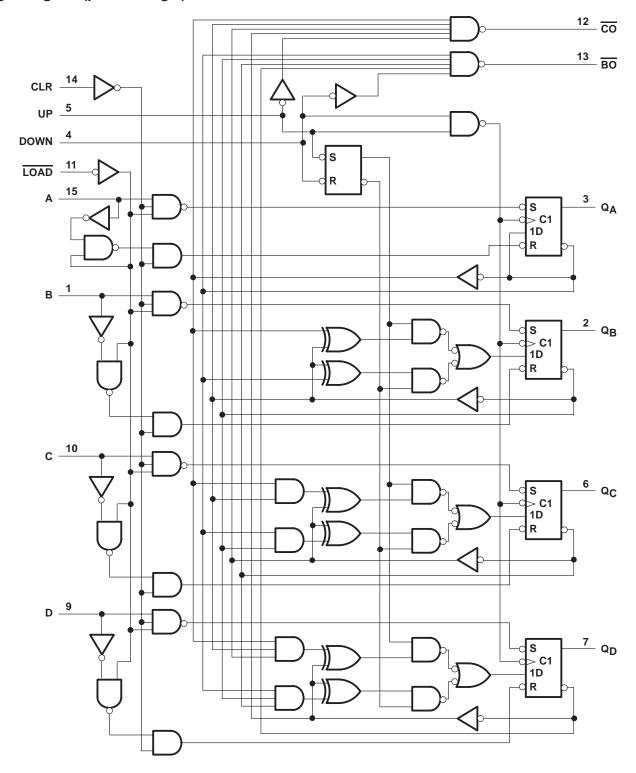


Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.



[‡] Package drawings, thermal data, and symbolization are available at http://www.ti.com/packaging.

logic diagram (positive logic)

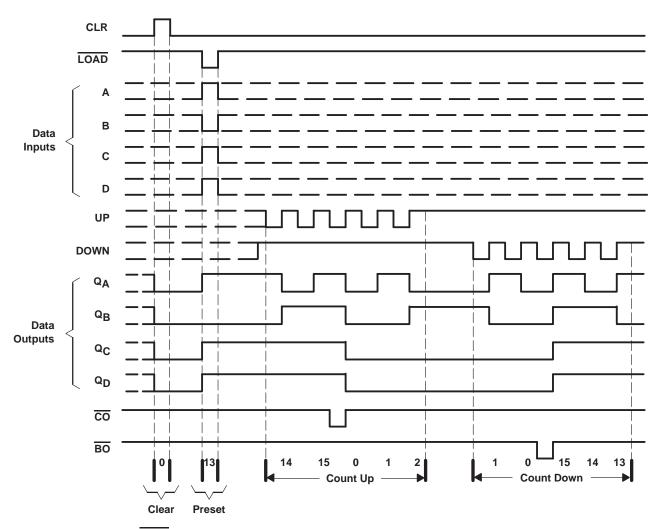




typical clear, load, and count sequence

The following sequence is illustrated below:

- 1. Clear outputs to 0
- 2. Load (preset) to binary 13
- 3. Count up to 14, 15, carry, 0, 1, and 2
- 4. Count down to 1, 0, borrow, 15, 14, and 13



NOTES: A. CLR overrides LOAD, data, and count inputs.

B. When counting up, count-down input must be high; when counting down, count-up input must be high.



SN74HC193-Q1 4-BIT SYNCHRONOUS UP/DOWN COUNTER (DUAL CLOCK WITH CLEAR)

SCLS594A - NOVEMBER 2004 - REVISED APRIL 2008

absolute maximum ratings over operating free-air temperature range (unless otherwise noted)†

Supply voltage range, V _{CC}	$-0.5\;V$ to 7 V
Input clamp current, I_{IK} ($V_I < 0$ or $V_I > V_{CC}$) (see Note 1)	±20 mA
Output clamp current, I _{OK} (V _O < 0 or V _O > V _{CC}) (see Note 1)	±20 mA
Continuous output current, I_O ($V_O = 0$ to V_{CC})	±25 mA
Continuous current through V _{CC} or GND	±50 mA
Package thermal impedance, θ_{JA} (see Note 2)	108°C/W
Storage temperature range, T _{stq}	-65°C to 150°C

[†] Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

NOTES: 1. The input and output voltage ratings may be exceeded if the input and output current ratings are observed.

recommended operating conditions (see Note 3)

			MIN	NOM	MAX	UNIT		
Vcc	Supply voltage		2	5	6	V		
		V _{CC} = 2 V	1.5					
ViH	High-level input voltage	V _{CC} = 4.5 V	3.15			V		
		V _{CC} = 6 V	4.2					
		V _{CC} = 2 V			0.5			
VIL	Low-level input voltage	V _{CC} = 4.5 V			1.35	V		
		V _{CC} = 6 V			1.8			
VI	Input voltage		0		VCC	V		
VO	Output voltage		0		VCC	V		
		V _{CC} = 2 V			1000			
Δt/Δv [‡]	Input transition rise/fall time	V _{CC} = 4.5 V			500	ns		
		V _{CC} = 6 V			400			
т.	On existing free six temperature	Q-suffix devices	-40		125	°C		
TA	Operating free-air temperature	I-suffix devices	-40		85	J.		

NOTE 3: All unused inputs of the device must be held at V_{CC} or GND to ensure proper device operation. Refer to the TI application report, Implications of Slow or Floating CMOS Inputs, literature number SCBA004.



^{2.} The package thermal impedance is calculated in accordance with JESD 51-7.

[‡] If this device is used in the threshold region (from V_{IL}max = 0.5 V to V_{IH}min = 1.5 V), there is a potential to go into the wrong state from induced grounding, causing double clocking. Operating with the inputs at t_t = 1000 ns and V_{CC} = 2 V does not damage the device; however, functionally, the CLK inputs are not ensured while in the shift, count, or toggle operating modes.

SN74HC193-Q1 4-BIT SYNCHRONOUS UP/DOWN COUNTER (DUAL CLOCK WITH CLEAR) SCLS594A - NOVEMBER 2004 - REVISED APRIL 2008

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER	TEST CO	TEST CONDITIONS		Т	A = 25°C	;	T _A = -		T _A = -		UNIT	
			VCC	MIN	TYP	MAX	MIN	MAX	MIN	MAX		
			2 V	1.9	1.998		1.9		1.9			
		$I_{OH} = -20 \mu A$	4.5 V	4.4	4.499		4.4		4.4			
VOН	VI = VIH or VIL		6 V	5.9	5.999		5.9		5.9		V	
		$I_{OH} = -4 \text{ mA}$	4.5 V	3.98	4.3		3.7		3.84			
		$I_{OH} = -5.2 \text{ mA}$	6 V	5.48	5.8		5.2		5.34			
		I _{OL} = 20 μA	2 V		0.002	0.1		0.1		0.1		
			4.5 V		0.001	0.1		0.1		0.1		
VOL	$V_I = V_{IH}$ or V_{IL}		6 V		0.001	0.1		0.1		0.1	V	
		I _{OL} = 4 mA	4.5 V		0.17	0.26		0.4		0.33		
		I _{OL} = 5.2 mA	6 V		0.15	0.26		0.4		0.33		
IĮ	$V_I = V_{CC}$ or 0		6 V		±0.1	±100		±1000		±1000	nA	
Icc	$V_I = V_{CC}$ or 0, $I_O = 0$		6 V			8		160		80	μΑ	
Ci		_	2 V to 6 V		3	10		10		10	pF	

SN74HC193-Q1 4-BIT SYNCHRONOUS UP/DOWN COUNTER (DUAL CLOCK WITH CLEAR) SCLS594A - NOVEMBER 2004 - REVISED APRIL 2008

timing requirements over recommended operating free-air temperature range (unless otherwise noted)

			VCC	T _A =	25°C	T _A = -		T _A = -		UNIT	
				MIN	MAX	MIN	MAX	MIN	MAX		
			2 V		4.2		2.8		3.3		
fclock	Clock frequency		4.5 V		21		14		17	MHz	
			6 V		24		16		19		
			2 V	120		180		150			
		CLR high	4.5 V	24		36		30			
			6 V	21		31		26			
			2 V	120		180		150			
t _w	Pulse duration	LOAD low	4.5 V	24		36		30		ns	
			6 V	21		31		26			
			2 V	120		180		150			
		UP or DOWN, high or low	4.5 V	24		36		30			
			6 V	21		31		26			
			2 V	110		165		140			
		Data before LOAD inactive	4.5 V	22		33		28			
			6 V	19		28		24			
			2 V	110		165		140			
t _{su}	Setup time	CLR inactive before UP↑ or DOWN↓	4.5 V	22		33		28		ns	
			6 V	19		28		24			
			2 V	110		165		140			
		LOAD inactive before UP↑ or DOWN↓	4.5 V	22		33		28		1	
			6 V	19		28		24			
	<u> </u>		2 V	5		5		5			
th	Hold time	Data after LOAD inactive	4.5 V	5		5		5		ns	
			6 V	5		5		5			

SN74HC193-Q1 **4-BIT SYNCHRONOUS UP/DOWN COUNTER** (DUAL CLOCK WITH CLEAR) SCLS594A - NOVEMBER 2004 - REVISED APRIL 2008

switching characteristics over recommended operating free-air temperature range, C_L = 50 pF (unless otherwise noted) (see Figure 1)

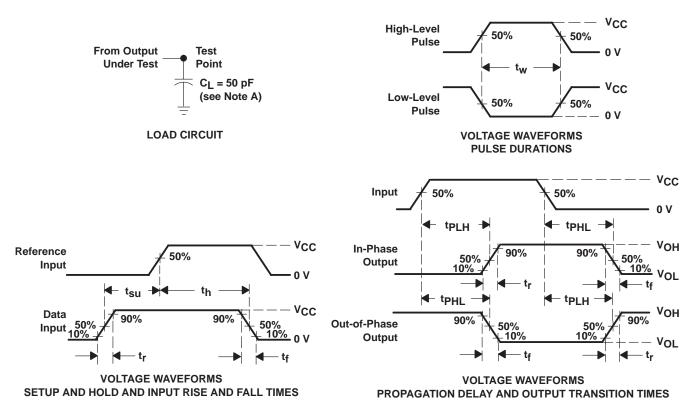
PARAMETER	FROM	TO	vcc	T,	4 = 25°C	;	T _A = -	-40°C 25°C	T _A = -		UNIT
	(INPUT)	(OUTPUT)		MIN	TYP	MAX	MIN	MAX	MIN	MAX	
			2 V	4.2	8		2.8		3.3		
f _{max}			4.5 V	21	55		14		17		MHz
			6 V	24	60		16		19		
			2 V		75	165		250		205	
	UP	CO	4.5 V		24	33		50		41	
			6 V		20	28		43		35	
		BO	2 V		75	165		250		205	
	DOWN		4.5 V		24	33		50		41	ns
			6 V		20	28		43		35	
^t pd	UP or DOWN		2 V		190	250		375		315	
		Any Q	4.5 V		40	50		75		63	
			6 V		35	43		64		54	
		Any Q	2 V		190	260		390		325	
	LOAD		4.5 V		40	52		78		65	
			6 V		35	44		66		55	
			2 V		170	240		360		300	
^t PHL	CLR	Any Q	4.5 V		36	48		72		60	ns
			6 V		31	41		61		51	
			2 V		38	75		110		95	
tţ		Any	4.5 V		8	15		22		19	ns
			6 V		6	14		19		17	

operating characteristics, $T_A = 25^{\circ}C$

	PARAMETER	TEST CONDITIONS	TYP	UNIT
C _{pd}	Power dissipation capacitance	No load	50	pF

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PARAMETER MEASUREMENT INFORMATION



NOTES: A. C_I includes probe and test-fixture capacitance.

- B. Phase relationships between waveforms were chosen arbitrarily. All input pulses are supplied by generators having the following characteristics: PRR \leq 1 MHz, $Z_O = 50 \Omega$, $t_r = 6 \text{ ns}$, $t_f = 6 \text{ ns}$.
- C. For clock inputs, f_{max} is measured when the input duty cycle is 50%.
- D. The outputs are measured one at a time, with one input transition per measurement.
- E. tpLH and tpHL are the same as tpd.

Figure 1. Load Circuit and Voltage Waveforms



www.ti.com 23-May-2025

PACKAGING INFORMATION

Orderable part number	Status	Material type	Package Pins	Package qty Carrier	RoHS (3)	Lead finish/ Ball material	MSL rating/ Peak reflow	Op temp (°C)	Part marking (6)
SN74HC193QPWRG4Q1	Active	Production	TSSOP (PW) 16	2000 LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 125	HC193Q
SN74HC193QPWRG4Q1.A	Active	Production	TSSOP (PW) 16	2000 LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 125	HC193Q

⁽¹⁾ Status: For more details on status, see our product life cycle.

Multiple part markings will be inside parentheses. Only one part marking contained in parentheses and separated by a "~" will appear on a part. If a line is indented then it is a continuation of the previous line and the two combined represent the entire part marking for that device.

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OTHER QUALIFIED VERSIONS OF SN74HC193-Q1:

Catalog: SN74HC193

⁽²⁾ Material type: When designated, preproduction parts are prototypes/experimental devices, and are not yet approved or released for full production. Testing and final process, including without limitation quality assurance, reliability performance testing, and/or process qualification, may not yet be complete, and this item is subject to further changes or possible discontinuation. If available for ordering, purchases will be subject to an additional waiver at checkout, and are intended for early internal evaluation purposes only. These items are sold without warranties of any kind.

⁽³⁾ RoHS values: Yes, No, RoHS Exempt. See the TI RoHS Statement for additional information and value definition.

⁽⁴⁾ Lead finish/Ball material: Parts may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

⁽⁵⁾ MSL rating/Peak reflow: The moisture sensitivity level ratings and peak solder (reflow) temperatures. In the event that a part has multiple moisture sensitivity ratings, only the lowest level per JEDEC standards is shown. Refer to the shipping label for the actual reflow temperature that will be used to mount the part to the printed circuit board.

⁽⁶⁾ Part marking: There may be an additional marking, which relates to the logo, the lot trace code information, or the environmental category of the part.

PACKAGE OPTION ADDENDUM

www.ti.com 23-May-2025

Military: SN54HC193

NOTE: Qualified Version Definitions:

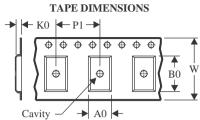
- Catalog TI's standard catalog product
- Military QML certified for Military and Defense Applications

PACKAGE MATERIALS INFORMATION

www.ti.com 3-Jun-2022

TAPE AND REEL INFORMATION





A0	Dimension designed to accommodate the component width
В0	Dimension designed to accommodate the component length
K0	Dimension designed to accommodate the component thickness
W	Overall width of the carrier tape
P1	Pitch between successive cavity centers

QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE

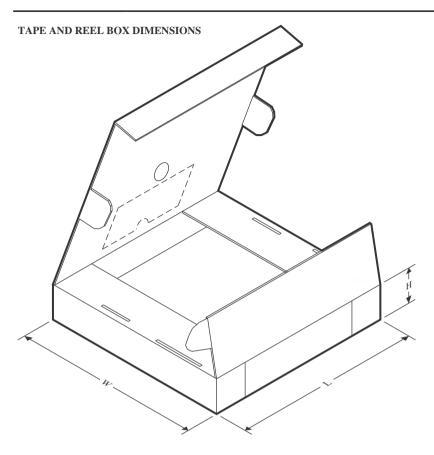


*All dimensions are nominal

Device	U	Package Drawing		SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
SN74HC193QPWRG4Q1	TSSOP	PW	16	2000	330.0	12.4	6.9	5.6	1.6	8.0	12.0	Q1

PACKAGE MATERIALS INFORMATION

www.ti.com 3-Jun-2022



*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)	
SN74HC193QPWRG4Q1	TSSOP	PW	16	2000	356.0	356.0	35.0	



SMALL OUTLINE PACKAGE



NOTES:

- 1. All linear dimensions are in millimeters. Any dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.

 2. This drawing is subject to change without notice.

 3. This dimension does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not
- exceed 0.15 mm per side.
- 4. This dimension does not include interlead flash. Interlead flash shall not exceed 0.25 mm per side.
- 5. Reference JEDEC registration MO-153.



SMALL OUTLINE PACKAGE



NOTES: (continued)

6. Publication IPC-7351 may have alternate designs.

7. Solder mask tolerances between and around signal pads can vary based on board fabrication site.



SMALL OUTLINE PACKAGE



NOTES: (continued)

- 8. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.
- 9. Board assembly site may have different recommendations for stencil design.



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